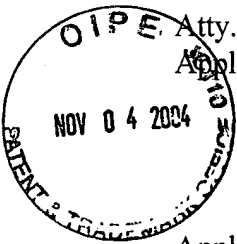


IFW \$



Atty. Docket No. CPAC 1029-6  
Appl. No. 10/681,747

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos	)	
	)	Examiner: Roy Karl Potter
Application No.: 10/681,747	)	
	)	Group Art Unit: 2822
Filed: October 8, 2003	)	
	)	Date: <u>November 1, 2004</u>
Title: <b>Semiconductor multi-package module</b>	)	
<b>having inverted second package</b>	)	
<b>and including additional die or stacked</b>	)	
<b>package on second package</b>	)	

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 1, 2004.

Signed Paula Faulk Hurley  
Paula Faulk Hurley

PRELIMINARY AMENDMENT  
AND RESPONSE TO RESTRICTION REQUIREMENT

Dear Sir:

Responsive to the Office action mailed September 29, 2004 (restriction only), Applicants elect:

Group I, claims 1 - 20, 41 and 42  
for prosecution in this application.

Preliminarily, kindly amend the application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

There are no amendments to the claims. A **Listing of Claims** is included for the Examiner's convenience, beginning on page 5 of this paper.

**Amendments to the Drawings** begin on page 10 of this paper and include both attached replacement sheets and annotated sheets showing changes.

**Remarks** begin on page 11 of this paper.

An **Appendix** including amended drawing figures is attached following page 12 of this paper.